

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
SHIGETO SUGIMOTO	02/20/2014
KOICHI KAJIYAMA	02/14/2014
MICHINOBU MIZUMURA	02/24/2014
SYUJI KUDO	02/27/2014
ERIKO KIMURA	02/24/2014
HANY MAHER AZIZ	02/19/2014
YOSHITAKA KAJIYAMA	02/19/2014
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	V TECHNOLOGY CO., LTD.
<b>Street Address:</b>	134, GODO-CHO, HODOGAYA-KU
<b>Internal Address:</b>	KANAGAWA
<b>City:</b>	YOKOHAMA-SHI
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	240-0005
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15071116
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(949)851-9348
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	9498510633
<b>Email:</b>	mlusian@mwe.com
<b>Correspondent Name:</b>	MCDERMOTT WILL & EMERY LLP
<b>Address Line 1:</b>	4 PARK PLAZA
<b>Address Line 2:</b>	SUITE 1700
<b>Address Line 4:</b>	IRVINE, CALIFORNIA 92614
<b>ATTORNEY DOCKET NUMBER:</b>	075523-0058
<b>NAME OF SUBMITTER:</b>	SOYEON PAK (KAREN) LAUB, REG. NO. 39266
<b>SIGNATURE:</b>	/Soyeon Pak (Karen) Laub/

PATENT

<b>DATE SIGNED:</b>	03/29/2016
<b>Total Attachments: 4</b> source=075523-0058Assignment#page1.tif source=075523-0058Assignment#page2.tif source=075523-0058Assignment#page3.tif source=075523-0058Assignment#page4.tif	

Docket No.: 075523-0034

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) <u>Shigeto SUGIMOTO</u>	(4) <u>Syuji KUDO</u>
(2) <u>Koichi KAJIYAMA</u>	(5) <u>Eriko KIMURA</u>
(3) <u>Michinobu MIZUMURA</u>	

who have made a certain new and useful invention, hereby sell, assign and transfer unto

V TECHNOLOGY CO., LTD., a corporation of JAPAN, whose post office address is  
134, Godo-cho, Hodogaya-ku, Yokohama-shi, Kanagawa, 240-0005 Japan

and its successors, assigns and legal representatives (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

DEPOSITION MASK, PRODUCING METHOD THEREFOR AND FORMING  
METHOD FOR THIN FILM PATTERN

for which an application for United States Letters Patent was filed on March 14, 2014, and identified by United States Application No. 14/214,428;

and the undersigned hereby authorize and request the registered practitioners of McDermott Will & Emery LLP to insert the filing date and application number of said application as necessary;

and the undersigned hereby authorize and request the United States Commissioner for Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, continuations-in-part and re-examinations thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to said ASSIGNEE, for its interest as ASSIGNEE; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

and the undersigned hereby agree to transfer a like interest, to render all necessary assistance in making application for and obtaining original, extended, divisional, reissued, substituted, renewed, continued, continued-in-part, and re-examined Letters Patent of the United States, upon request of said ASSIGNEE and without further remuneration, in and to any improvements and applications for patent based thereon, growing out of or related to said invention, and to execute any papers by or for said ASSIGNEE, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTOR	DATE SIGNED
1) <u><i>Shigeto Sugimoto</i></u> Name: Shigeto SUGIMOTO	<u>February 20, 2014</u>
INVENTOR	DATE SIGNED
2) <u><i>Koichi Kajiyama</i></u> Name: Koichi KAJIYAMA	<u>February, 14, 2014</u>
INVENTOR	DATE SIGNED
3) <u><i>Michinobu Mizumura</i></u> Name: Michinobu MIZUMURA	<u>February 24, 2014</u>
INVENTOR	DATE SIGNED
4) <u><i>Shuji Kudo</i></u> Name: Syuji KUDO	<u>February 27, 2014</u>
INVENTOR	DATE SIGNED
5) <u><i>Eriko Kimura</i></u> Name: Eriko KIMURA	<u>February, 28, 2014</u>

Docket No.: 075523-0034

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(6) Hany Maher Aziz (7) Yoshitaka KAJIYAMA

who have made a certain new and useful invention, hereby sell, assign and transfer unto

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DEPOSITION MASK, PRODUCING METHOD THEREFOR AND FORMING  
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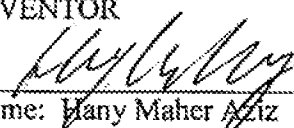
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and the undersigned hereby agree to transfer a like interest, to render all necessary assistance in making application for and obtaining original, extended, divisional, reissued, substituted, renewed, continued, continued-in-part, and re-examined Letters Patent of the United States, upon request of said ASSIGNEE and without further remuneration, in and to any improvements and applications for patent based thereon, growing out of or related to said invention, and to execute any papers by or for said ASSIGNEE, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

	INVENTOR	DATE SIGNED
6)	<u></u> Name: Hany Maher Aziz	<u>Feb 19/2014</u>

	INVENTOR	DATE SIGNED
7)	<u>Yoshitaka Kaji Yama</u> Name: Yoshitaka KAJIYAMA	<u>Feb 19/2014</u>